

MOSFETs Silicon 500V N-Channel MOS
■ Applications

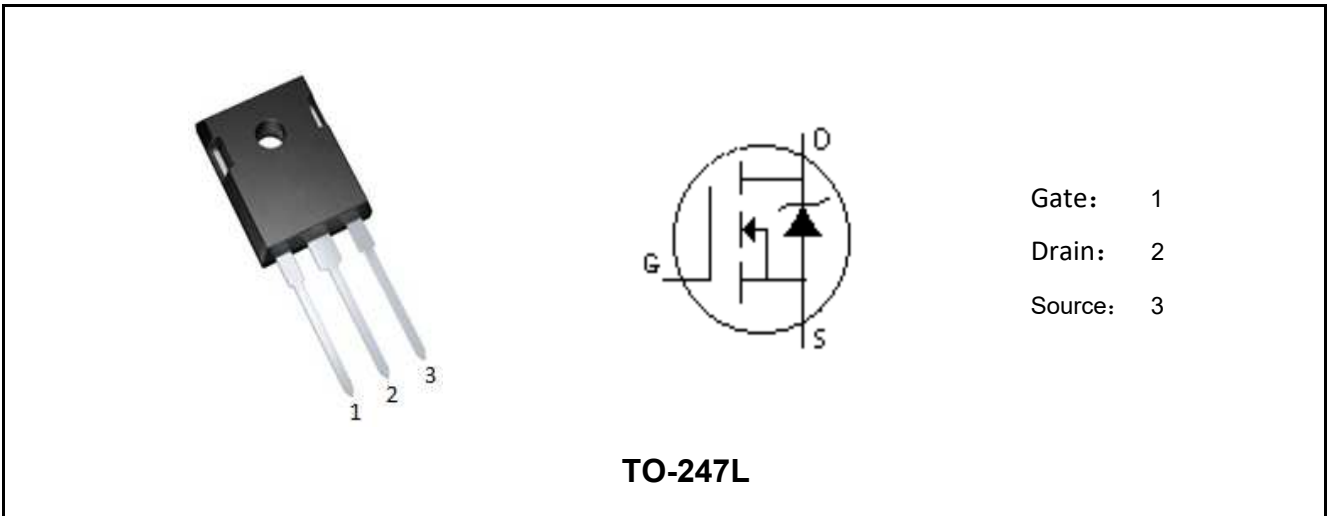
- PWM Inverters
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)

■ Features

- Low $R_{DS(ON)}$
- Low Gate Charge
- RoHS Compliant
- 100% UIS and RG Tested

■ Product Summary

| | | |
|-------------------------|-------|----------|
| V_{DS} | 500 | V |
| I_D | 50 | A |
| $R_{DS(ON)}, Typ @ 10V$ | 0.087 | Ω |
| Q_g | 137 | nC |



| Marking | Package | Packaging | Min. package quantity |
|-------------|---------|-----------|-----------------------|
| MSLIRF50N50 | TO-247L | Tube | 450 |



■ Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

| Parameter | | Symbol | Ratings | Unit |
|--|----------|-----------|---------|------|
| Drain-Source Voltage | | V_{DS} | 500 | V |
| Gate-Source Voltage | | V_{GS} | ±30 | V |
| Continuous Drain Current (Note 1) | TC=25°C | I_D | 50 | A |
| | TC=100°C | | 25 | A |
| Drain Current-Pulsed (Note 1) | | I_{DM} | 160 | A |
| Total Dissipation | | P_D | 417 | W |
| Junction Temperature | | T_j | 150 | °C |
| Storage Temperature | | T_{stg} | -55-150 | °C |
| Single Pulse Avalanche Energy (Note 2) | | E_{AS} | 5450 | mJ |

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

■ Thermal Characteristics

| Parameter | Symbol | Max | Unit |
|-----------------------------|-----------------|-----|------|
| Maximum Junction-to-Case | $R_{\theta JC}$ | 0.3 | °C/W |
| Maximum Junction-to-Ambient | $R_{\theta JA}$ | 40 | °C/W |

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: $V_{DD}=50V$, $T_{ch}=25^\circ C$ (initial), $L=10mH$, $R_g=25\Omega$.

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.



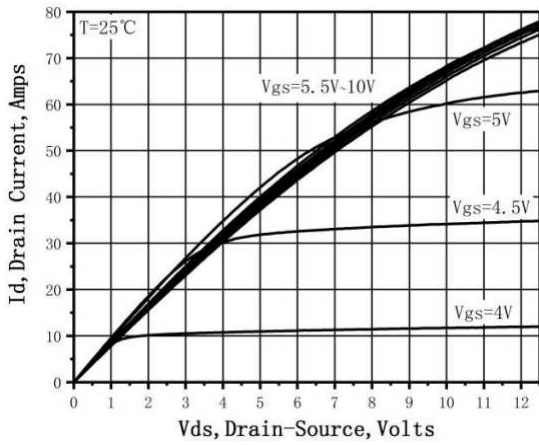
■ Electrical Characteristics (Tc=25°C unless otherwise noted)

| Parameter | Symbol | Test Condition | Min | Typ | Max | Unit |
|-------------------------------------|--------------|---|-----|-------|-----------|----------|
| Static Parameters | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | $V_{GS}=0V, I_D=250\mu A$ | 500 | - | - | V |
| Drain-Source Leakage Current | I_{DSS} | $V_{DS}=500V, V_{GS}=0V$ | - | - | 1 | μA |
| Gate-Body Leakage Current | I_{GSS} | $V_{GS}=\pm 30V, V_{DS}=0V$ | - | - | ± 100 | nA |
| Gate Threshold Voltage | $V_{GS(TH)}$ | $V_{GS}=V_{DS}, I_D=250\mu A$ | 2 | 2.7 | 4 | V |
| Drain-Source On Resistance | $R_{DS(ON)}$ | $V_{GS}=10V, I_D=25A$ | - | 0.087 | 0.1 | Ω |
| Dynamic Characteristics | | | | | | |
| Input Capacitance | C_{iss} | $V_{DS}=25V, V_{GS}=0V,$ $f=1.0MHz$ | - | 8490 | - | pF |
| Output Capacitance | C_{oss} | | - | 720 | - | pF |
| Reverse Transfer Capacitance | C_{rss} | | - | 40 | - | pF |
| Gate Resistance | R_g | $V_{DS}=0V, V_{GS}=0V,$ $f=1.0MHz$ | - | 1.3 | - | Ω |
| Switching Parameters | | | | | | |
| Turn-On Delay Time | $t_{d(on)}$ | $V_{DS}=250V, I_D=25A,$ $V_{GS}=10V, R_G=25\Omega$ | - | 25 | - | ns |
| Turn-On Rise Time | t_r | | - | 170 | - | ns |
| Turn-Off Delay Time | $t_{d(off)}$ | | - | 50 | - | ns |
| Turn-Off Fall Time | t_f | | - | 70 | - | ns |
| Total Gate Charge | Q_g | $V_{DS}=400V, I_D=25A,$ $V_{GS}=10V$ | - | 137 | - | nC |
| Gate-Source Charge | Q_{gs} | | - | 14 | - | nC |
| Gate-Drain Charge | Q_{gd} | | - | 26 | - | nC |
| Source-Drain Characteristics | | | | | | |
| Max. Diode Forward Current | I_S | | - | - | 50 | A |
| Max. Pulsed Forward Current | I_{SM} | | - | - | 160 | A |
| Diode Forward Voltage | V_{SD} | $V_{GS}=0V, I_S=25A$ | - | 0.9 | 1.5 | V |
| Reverse Recovery Time | t_{rr} | $V_R=400V, I_F=30A,$ $di/dt=100A/\mu s$ | - | 470 | - | ns |
| Reverse Recovery Charge | Q_{rr} | | - | 7.7 | - | μC |

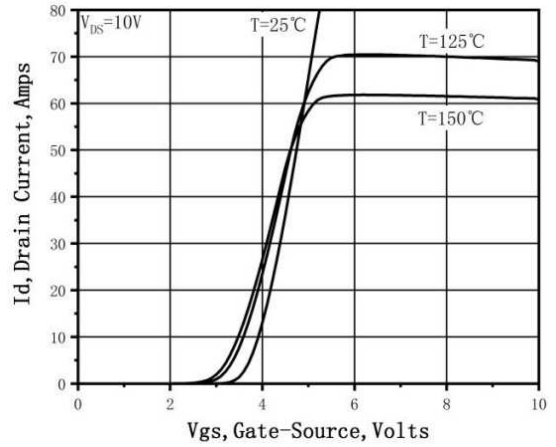




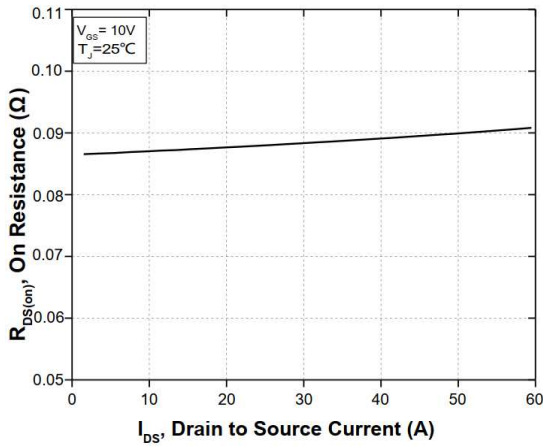
■ Characteristics Curves



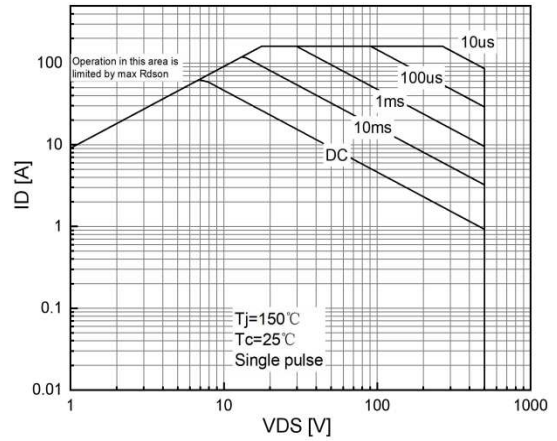
Output Characteristics



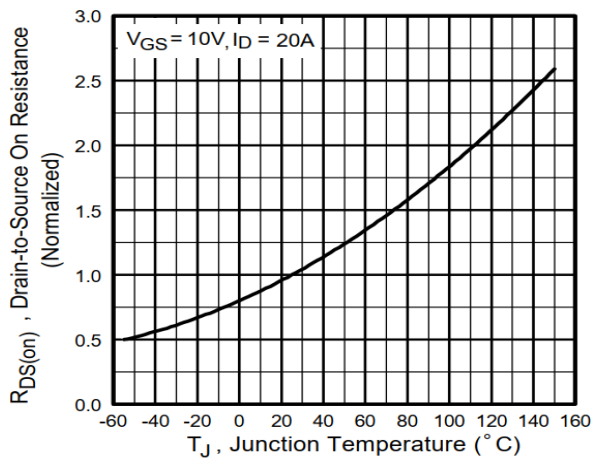
Transfer Characteristics



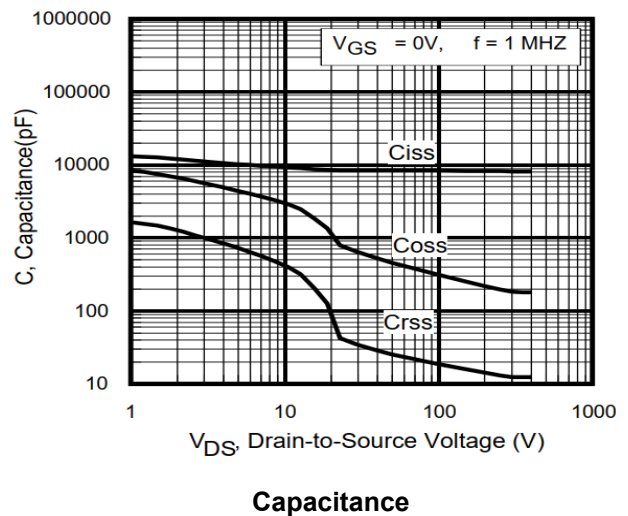
On Resistance Vs Drain Current



Safe Operating Area

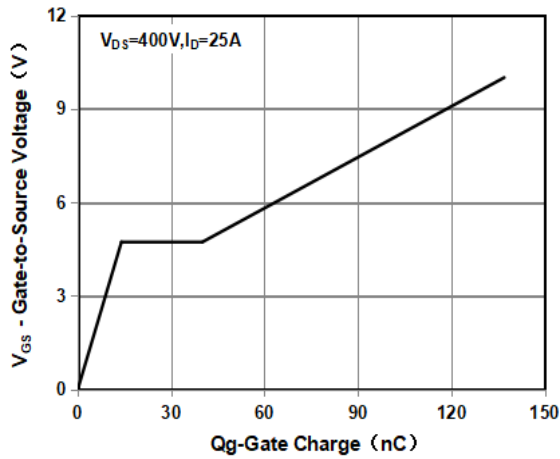


Rdson-Junction Temperature

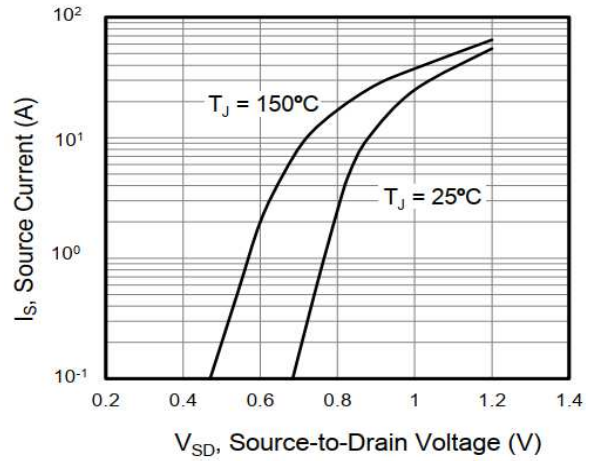


Capacitance

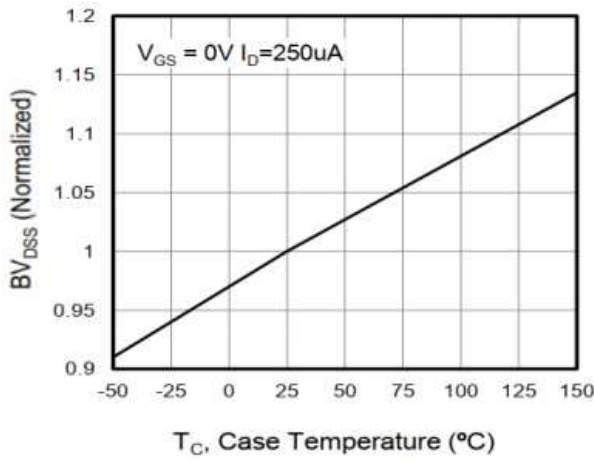




Gate Charge Waveform



Source-Drain Diode Forward Voltage



Breakdown Voltage Vs Junction Temperature

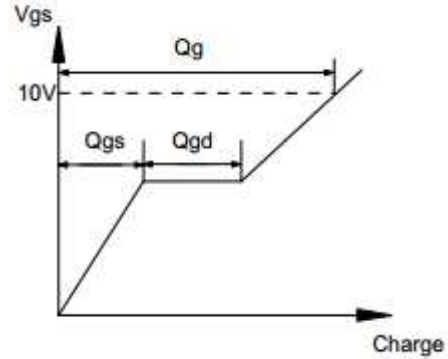
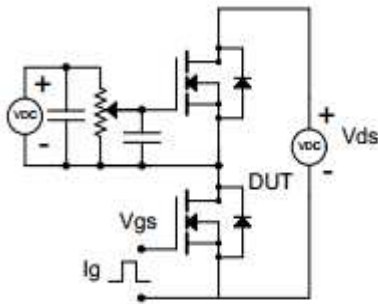
Note : The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



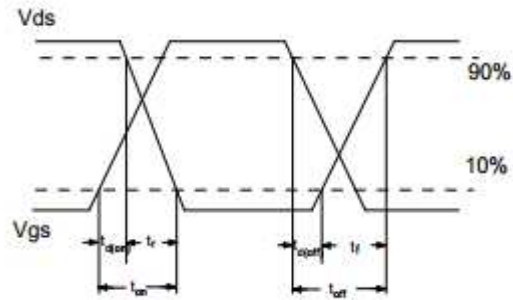
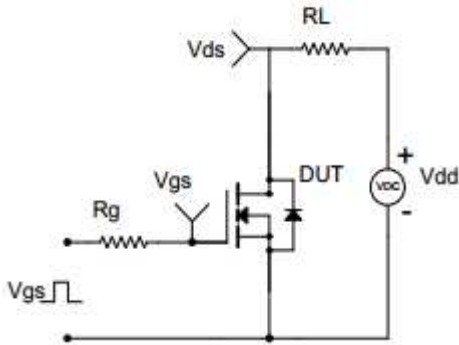


■ Test Circuit & Waveform

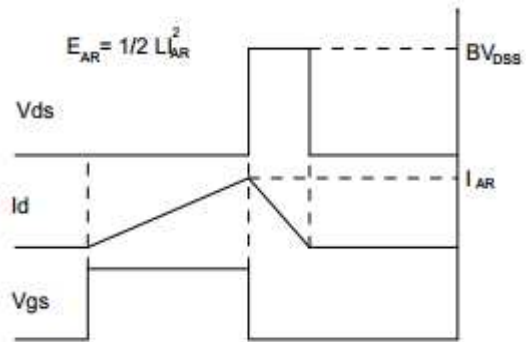
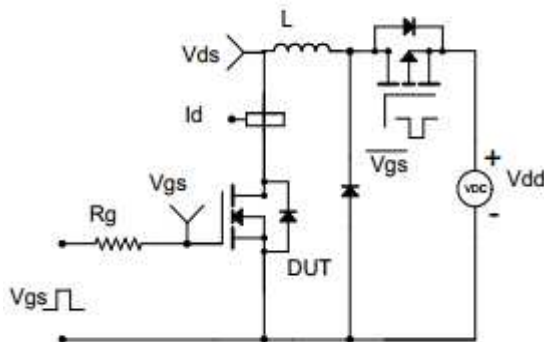
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveform



Unclamped Inductive Switching (UIS) Test Circuit & Waveform





■ TO-247L Package Dimensions

Unit: mm

| Symbol | Min | Nom | Max | Symbol | Min | Nom | Max |
|--------|-------|------|-------|--------|-------|------|-------|
| A | 4.80 | | 5.20 | E1 | 13.00 | | 13.60 |
| A1 | 2.20 | 2.40 | 2.60 | E2 | 5.00 | | 5.50 |
| A2 | 1.85 | | 2.15 | E3 | 1.90 | | 2.60 |
| b | 1.07 | | 1.33 | e | | 5.44 | |
| b2 | 1.90 | | 2.16 | L | 19.30 | | 19.90 |
| b4 | 2.90 | | 3.20 | L1 | 3.75 | 3.95 | 4.15 |
| c | 0.52 | | 0.68 | ΦP | 3.40 | | 3.80 |
| D | 20.70 | | 21.30 | ΦP1 | 7.00 | | 7.40 |
| D1 | 16.15 | | 16.95 | S | 6.04 | 6.15 | 6.30 |
| E | 15.50 | | 16.10 | | | | |

